

manufactured by the method of manufacturing defined in claim 1.

5 5. A surface acoustic wave device comprising a plurality of surface acoustic wave elements, each having a comb electrode formed on a piezoelectric substrate and connection terminals connected to the comb electrode; and a package which has a die attach surface to which each of the connection terminals is joined or bonded through a bonding member, and in which
10 said plurality of surface acoustic wave elements are housed side by side,

wherein the bonding member has a shape elongated in a direction substantially perpendicular to a direction in which said surface acoustic wave elements are juxtaposed.
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20 6. A surface acoustic wave device according to claim 5, wherein said plurality of surface acoustic wave elements include a surface acoustic wave element having a frequency characteristic different from that of other surface acoustic wave elements.

25 7. A surface acoustic wave device according to claim 5, wherein the connection terminal is formed into an elongated shape which is shorter along a direction in which said surface acoustic wave elements are juxtaposed.